TOSHIBA TRANSISTOR SILICON PNP EPITAXIAL TYPE (DARLINGTON POWER TRANSISTOR)

2 S B 1 5 9 4

POWER AMPLIFIER APPLICATIONS

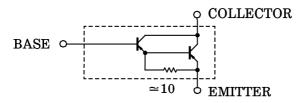
High Breakdown Voltage : $V_{CEO} = -160 V$ (Min.)

Complementary to 2SD2449

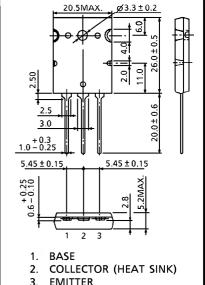
MAXIMUM RATINGS (Tc = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	v_{CBO}	-160	V
Collector-Emitter Voltage	v_{CEO}	-160	V
Emitter-Base Voltage	$V_{ m EBO}$	-5	V
Collector Current	$I_{\mathbf{C}}$	-10	A
Base Current	$I_{\mathbf{B}}$	-1	A
Collector Power Dissipation (Tc=25°C)	PC	150	w
Junction Temperature	T_{j}	150	°C
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~150	°C

EQUIVALENT CIRCUIT



Unit in mm



3. EMITTER

JEDEC	_	
JEITA	_	
TOSHIBA	2-21FIA	

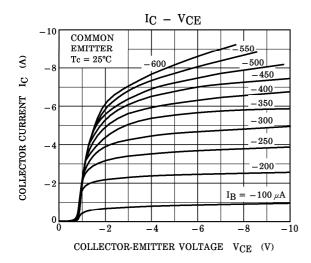
Weight: 9.75 g (Typ.)

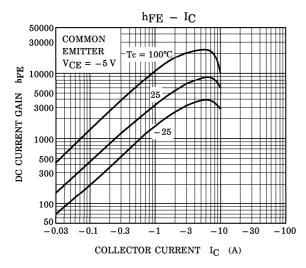
ELECTRICAL CHARACTERISTICS (Tc = 25°C)

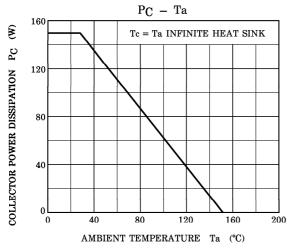
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	$I_{ m CBO}$	$V_{CB} = -160 \text{ V}, I_{E} = 0$	_	_	-5	μ A
Emitter Cut-off Current	$I_{ m EBO}$	$V_{EB} = -5 \text{ V}, I_{C} = 0$	_	_	-5	μ A
Collector-Emitter Breakdown Voltage	V (BR) CEO	$I_{\rm C} = -50 {\rm mA}, I_{\rm B} = 0$	-160	_	_	V
IDC Current Gain	h _{FE (1)} (Note)	$V_{CE} = -5 \text{ V}, I_{C} = -8 \text{ A}$	3000	_	20000	
	h _{FE} (2)	$V_{CE} = -5 \text{ V}, I_{C} = -12 \text{ A}$	2000	_	_	
Collector-Emitter Saturation Voltage	V _{CE} (sat)	$I_{\rm C} = -8{\rm A},\ I_{\rm B} = -8{\rm mA}$	_	_	-3.0	V
Base-Emitter Voltage	$ m V_{BE}$	$V_{CE} = -5 \text{ V}, I_{C} = -8 \text{ A}$	_	_	-3.0	V
Transition Frequency	$ m f_{T}$	$V_{CE} = -5 \text{ V}, I_{C} = -1 \text{ A}$	_	30	_	MHz
Collector Output Capacitance	C _{ob}	$V_{CB} = -10 V, I_{E} = 0,$ f = 1 MHz	_	150	_	pF

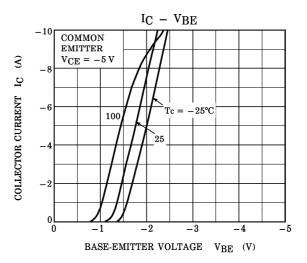
 $(Note): h_{FE\;(1)}\; Classification \qquad \quad A: 3000 {\sim} 10000, \quad B: 5000 {\sim} 15000, \quad C: 7000 {\sim} 20000$

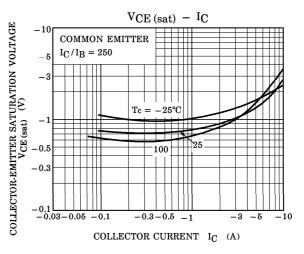
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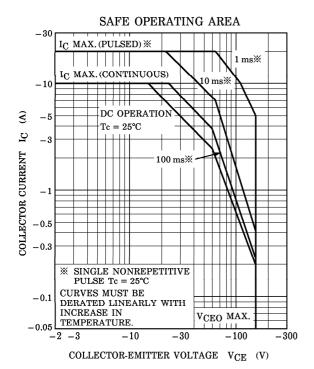








2 2001-10-29



3 2001-10-29

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